APPLICA	BLE STAND	ARD	SD Card Specifications Ve	r. 1.0							
	OPERATING TEMPERATURE	RANGE	E -25 °C TO +85 °C (NOTE1)		STORAG TEMPER/	E ATURE RANGE		-40 °C TO ·		+85 °C	
RATING VOLTAGE			AC 125V		1	PERATING HUMIDITY RANGE		95%l			
CURRENT		0.5A					(NON-CONDENSING		SING)		
			SPEC	CIFIC	ATION:		l				
	TEM		TEST METHOD				REQ	UIREMENTS		QT	АТ
CONSTRUC	TION					•					
	EXAMINATION		Y AND BY MEASURING IN	STRUME	ENT.	ACCO	RDING TO E	RAWING.		X	X
MARKING	CHARACTERIS1		MED VISUALLY.							×	×
	RESISTANCE		OLTAGE 20 mV AC MAX,			INITIAI	LY 100 mO	MAX (NOTE 2).		X	
	LEVEL METHOD 0512-2-2a		JRRENT 1mA.								_
VOLTAGE F		500 Vrms	AC IS APPLIED FOR 1 MIN	NUTE.		1 -		OR BREAKDOWN	1.	×	_
	0512-2-4a	MEASURE WITHIN 1 MINUTE AFTER APPLYING 500 V DC.				©CURRENT LEAKAGE 1mA MAX.				×	<u> </u>
	0512-2-3a	MEASURE	E WITHIN 1 MINUTE AFTER API	PLYING 50	00 V DC.	INITIAL	LY 1000 MΩ	2 MIN.		^	_
MECHANIC	AL CHARACTER	RISTICS									
CARD INSE	RTION FORCE					THE INITIAL STAGE:10 N MAX. AFTER MECHANICAL OPERATION:10N MAX.				×	-
MECHANIC	AL OPERATION	10000 TI	MES INSERTIONS AND WI	TH DRAV	WAL SHALL		NTACT RES	SISTANCE:		×	_
	NVIRONMENT]	BE MADE AT THE CYCLE RATE 400 TO 600 CYCLES/h.			AFTER TEST 40 m $\Omega$ MAX CHANGE.						
EIA36	4B class1.1					1 '		ΓANCE REVERSION XTRACTION IS VAIL			
						1		AL DAMAGE SHAL	,		
							CUR ON TH				
VIBRATION FREQUENC		FREQUENCY 10 TO 55 TO 10 Hz/min, SINGLE  AMPLITUDE 0.75 mm FOR 2 h IN 3 DIRECTIONS.			① NO E	ELECTRICAL	. DISCONTINUITY OF	F 100	×	_	
IEC60512-4-6d		AND ETTOBLE 5.75 THINT ON 2 IT IN 3 BINCO HONG.			NO MECHANICAL DAMAGE SHALL     OCCUR ON THE PARTS.						
SHOCK	0540.4.0-		ATION 490m/s <sup>2</sup> STANDARD H			1				×	-
	0512-4-6c ENTAL CHARAC	1	E WAVE FOR 3TIMES IN 3 DIR	ECTIONS.	•						
DAMP HEA			ES (1 CYCLE=24 HOURS)WITH	CONNECT	TORS	① CON	NTACT RES	ISTANCE:		T X	
IEC60512-6-11m		ENGAGED.  End of temperature rise Beginning of temperature descent  100% 96% 100% 96% 15min 15min 15min 15min  MAX temp2°C  100% 100%				AFTER TEST 40 mΩ MAX CHANGE.  ② INSULATION RESISTANCE: AFTER TEST 100 MΩ MIN.  ③ NO MECHANICAL DAMAGE OR HEAVY CORROSION SHALL OCCUR ON THE PARTS.					
		erence temperature	1/2h 1/2h 3/2h 12±1/2h 24h	6h >	+28°C ************************************						
COUN	T DE	SCRIPTIC	N OF REVISIONS		DESIGN	ED		CHECKED		DA	ATE
A DEMARK							 			+	
REMARK NOTE 1:INC	LUDE THE TEM	PERATURE RISE BY CURRENT					+		1		
NOTE 2:CON	APPROVED KI.AKIYAMA 05.12.0  LUDE THE TEMPERATURE RISE BY CURRENT.  CHECKED SI.TOMIOKA 05.12.0  CHECKED SI.TOMIOKA 05.12.0  CHECKED SI.TOMIOKA 05.12.0										
			THE TEST SHOULD BE		INDER TEM	IP. 15 -	DESIGNEL		1	_	12.05
		06kPa, RELATIVE HUMIDITY 25 - 85%.  AT:Assurance Test X:Applicable Test DRA			WING NO.		HM.SAITO C			ız.UI	
			ECIFICATION SHEET  PART						DM1B-DSF-PEJ(82)		
HS.		HIROSE ELECTRIC CO., LTD.				VO	CL609-0003-5-82			<b>A</b>	1/2
	111110				CODE NO.		0003-0003-3-02				

		SPECIFICA <sup>-</sup>	TION	IS				
ITEM	1	TEST METHOD			REQU	REMENTS	QT	AT
RAPID CHANGE TEMPERATURE IEC60512-	•	5 CYCLES (1 CYCLE=1 HOUR)WITH CONNECTENGAGED.  TEMPERATURE:-55 to +85°C		AFT	NTACT RESIS TER TEST 40 r TULATION RESIDER TEST 100	nΩ MAX CHANGE.	×	-
DRY HEAT IEC60512	-6-11i	EXPOSED AT 85 °C FOR 96 HOURS WITH CONNECTORS ENGAGED.		3 NO I	MECHANICAL I	DAMAGE OR HEAVY LL OCCUR ON THE PART	S.	_
COLD IEC60512	-6-11j	EXPOSED AT -25 °C FOR 96 HOURS WITH CONNECTORS ENGAGED.					×	-
DAMP HEAT, STEADY STATE IEC60512		EXPOSED AT 40 °C,90 TO 95 % RH, 96 HOUR! CONNECTORS ENGAGED.	S WITH				X	-
HYDROGEN SU JEIDA		EXPOSED IN 3 PPM HYDROGEN SULFIDE , APPROX. 80% RH,96 HOURS, WITH CONNEC ENGAGED.	TORS				×	-
CORROSION SA (JIS C 540		EXPOSED IN $5\pm1$ % SALT WATER SPRAY , $35\pm2^{\circ}$ C,48 HOURS, WITH CONNECTORS ENGARTER THE TEST,THE TEST SAMPLE SHALL RINSED WITH WATER AND DRIED AT THE AMBIENT TEMP. FOR 24 HOURS.	NGED.		OSION SHALL	AMAGE OR HEAVY OCCUR ON THE	×	_
Note QT:Qualification Test AT:Assurance Test X:Applicable Test				 DRAWING NO.		ELC4-15356	1 3-03	
HS.	SPECIFICATION SHEET			PART NO.		DM1B-DSF-PEJ(82)		
11/2	HIROSE ELECTRIC CO., LTD.			E NO	CL609	-0003-5-82	<b>△</b> 2	2/2